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## Spin phase protection in interference of electron spin waves in lightly hydrogenated graphene

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Electron spin transport in graphene is extremely sensitive to foreign atoms and ripples of  $SiO_2$  substrate. Indeed, observed spin diffusion- and relaxation-length (time) were smaller than theoretically expected one owing to them, although a large spin diffusion length has been recently realized in graphene synthesized on SiC substrate. It is, thus, crucial to enhance spin phase coherence and spin diffusion (relaxation) length of graphene/ $SiO_2$  substrate particularly for future graphene spintronics. One of approaches to realize them is investigation of spin phase in phase interference phenomena of electron spin waves (such as weak localization (WL)) and its correlation with spin-orbit-interaction (SOI). However, those coexistence in graphene is difficult to be realized experimentally. Here, we have realized extremely light hydrogenation of graphene surface (<< 0.1%) on  $SiO_2$  by precisely controlling the amount of electron beam (EB) irradiation to a specific EB resist including hydrogen atoms, treated on graphene. It allows coexistence of WL and SOI. We find spin phase protection (suppression of dephasing) of electron-spin-waves in WL on temperature and external magnetic-field dependence in the graphenes with hydrogenation volume ( $N_H$ ) as small as 0.06%. As an origin, correlation of the WL with Rashba-type SOI, which can be introduced by out-of-plane symmetry breaking due to formation of  $Sp^3$  bonds derived from the small  $N_H$ , is discussed. The present finding in lightly hydrogenated graphene must be beneficial for graphene spintronics, which requests long spin diffusion- and coherence-length. It will realize a possible 2D-topological insulating state in graphene.

トポロジカル絶縁体は次世代スピントロニクスのキーテクノロジーとして熱い注目を集めています。スピン軌道相互作用 (SOI)がその鍵ですが、今回グラフェンに塗布した特殊レジストに電子線照射することでグラフェン表面を微量水素修飾し、面直対称性を破壊、SOIの導入に成功しました。さらに<u>電子波位相干渉(弱局在)</u>において、この<u>SOIの有効磁場がスピン位相破壊を抑制する</u>可能性を見出しました(論文は下記リンク)





